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			2138	

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Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)		
	10/632,928	KOBAYASHI ET AL.		
Office Action Summary	Examiner	Art Unit		
	Saqib J. Siddiqui	2138		
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address		
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim viil apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONEI	J. lely filed the mailing date of this communication. D (35 U.S.C. § 133).		
Status				
Responsive to communication(s) filed on <u>04 Au</u> This action is FINAL . 2b)⊠ This Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro			
Disposition of Claims				
4) Claim(s) 1-9 is/are pending in the application. 4a) Of the above claim(s) is/are withdraw 5) Claim(s) is/are allowed. 6) Claim(s) 1-9 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or Application Papers 9) The specification is objected to by the Examine 10) The drawing(s) filed on 04 August 2003 is/are: Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examine 11) The oath or declaration is objected to by the Examine 11) The oath or declaration is objected to by the Examine 11) The oath or declaration is objected to by the Examine 11) The oath or declaration is objected to by the Examine 11 The oath or declaration is objected to by the Examine 11 The oath or declaration is objected to by the Examine 11 The oath or declaration is objected to by the Examine 12 The oath or declaration is objected to by the Examine 12 The oath or declaration is objected to by the Examine 12 The oath or declaration is objected to by the Examine 12 The oath or declaration is objected to by the Examine 12 The oath or declaration is objected to by the Examine 13 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected to by the Examine 14 The oath or declaration is objected	r election requirement. r. a)⊠ accepted or b)□ objected to the discount of t	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).		
Priority under 35 U.S.C. § 119				
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.				
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 08/04/03.	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:			

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DETAILED ACTION

Priority

Acknowledgment is made of applicant's claim for foreign priority under 35 U.S.C. 119(a)-(d). The certified copy has been filed in Application No. 10/632928, filed on August 04, 2003. Priority date of March 18, 2003 has been assigned.

Oath/Declaration

The Oath filed August 04, 2003 complies with all the requirements set fort in MPEP 602 and therefore is accepted.

Drawings

The filed drawings are accepted.

Specification

The contents of the filed specification are accepted.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1-3 & 6-9 are rejected under 35 U.S.C. 102(b) as being fully anticipated by Urakawa US Patent no. US 6,324,106 B2.

As per claim 1:

Urakawa teaches a semiconductor integrated circuit comprising: a comparator (Figure 11 # 113) comparing a value of data read from each memory cell (Figure 11 # 110) connected to an activated word line with an expected value to be read from said each memory cell (Figure 11 # 113b), for each column in a test mode, an error register accumulatively holding error data based on a comparison result by said comparator (Figure 11 # 22), wherein each bit (Figure 15 "Bit Line", column 8, lines 48-50) of said error data indicates said comparison result by said comparator for a corresponding column, and said each bit takes a first logical value when said comparison result for said corresponding column always indicates equality whichever word line is activated (column 8, lines 57-62), and takes a second logical value when once said comparison result for said corresponding column indicates difference (column 9, lines 10-15).

As per claim 2:

Urakawa teaches the semiconductor integrated circuit according to claim 1, wherein said semiconductor integrated circuit has a plurality of modules connected to a common internal data bus (Figures 7,8,10 have an internal data bus) and performing reading operations from memory cells simultaneously in the test mode (Figure 7 # 1), and said each module includes a switch circuit prohibiting data read from a memory cell from being output to the internal data bus in the test mode (column 8, line 60-65).

As per claim 3:

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Urakawa teaches the semiconductor integrated circuit according to claim 1, wherein said semiconductor integrated circuit has a plurality of modules having their operations controlled by respective chip select signals (column 8, lines 41-45), and said each module has a control circuit controlling an operation of reading or writing data from or into a memory cell (column 4, lines 59-63), irrespective of a value of said chip select signal, in the test mode.

As per claim 6:

Urakawa teaches the semiconductor integrated circuit according to claim 1, wherein said semiconductor integrated circuit has a redundancy circuit in a column (column 4, lines 32-34).

As per claim 7

Urakawa teaches the semiconductor integrated circuit according to claim 6, wherein said error register outputs held error data when an address signal indicates a prescribed value (column 10, lines 42-45), said semiconductor integrated circuit further comprising a repair code generation circuit receiving said error data for generating a repair code for repairing a defective memory cell array using said redundancy circuit (column 6, lines 10-11).

As per claim 8:

Urakawa teaches the semiconductor integrated circuit according to claim 7 comprising: a program circuit including at least one fuse element for outputting a repair code corresponding to a state of said fuse element (column 4, lines 39-41); a register holding a repair code (column 6, lines 8-101); a selector selecting and outputting one of the repair code output from said program circuit and the

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repair code output from said register (column 10, lines 30-35); and a repair control circuit controlling repair of a defective memory cell array in accordance with the repair code output from said selector (column 6, lines 12-14).

As per claim 9:

Urakawa teaches the semiconductor integrated circuit according to claim 6 comprising: a program circuit including at least one fuse element for outputting a repair code corresponding to a state of said fuse element (column 5, lines 60-65); a register holding a repair code (column 6, lines 8-10); a selector selecting and outputting one of the repair code output from said program circuit and the repair code output from said register (column 10, lines 30-35); a repair control circuit controlling repair of a defective memory cell array in accordance with the repair code output from said selector (column 6, lines 12-14); and a processor (column 6, lines 54-55) controlling an execution of a two-step test, wherein said processor controls writing of test data into a memory cell (column 5, lines 26-28) and reading of test data from a memory cell without causing said repair control circuit to perform repair in a first step of the test (Figure 7 # 3, column 8, lines 42-44), generates a repair code corresponding to error data stored in said error register in said first step of the test for storage into said register, and controls writing of test data (column 5, lines 26-28) into a memory cell and reading of test data from a memory cell (column 5, lines 28-30) while allowing said selector to output the repair code from said register to cause said repair control circuit to perform the repair.

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Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1-6 are rejected under 35 U.S.C. 102(b) as being fully anticipated by Kawamata US PG Pub no. US 2001/0042231 A1.

As per claim 1:

Kawamata teaches a semiconductor integrated circuit comprising: a comparator (paragraph [0029], lines 1-2) comparing a value of data read from each memory cell (paragraph [0029], lines 3-4) connected to an activated word line with an expected value to be read from said each memory cell (paragraph [0029], lines 4-5), for each column in a test mode, an error register accumulatively holding error data based on a comparison result by said comparator (paragraph [0030], lines 1-4), wherein each bit (paragraph [0056], lines 1-2) of said error data indicates said comparison result by said comparator for a corresponding column (paragraph [0039], lines 5-12), and said each bit takes a first logical value when said comparison result for said corresponding column always indicates equality whichever word line is activated, and takes a

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second logical value when once said comparison result for said corresponding column indicates difference (paragraph [0056], lines 2-6).

As per claim 2:

Kawamata teaches the semiconductor integrated circuit according to claim 1, wherein said semiconductor integrated circuit has a plurality of modules connected to a common internal data bus (Figure 5 # channels D0-D3) and performing reading operations from memory cells simultaneously in the test mode (paragraph [0076], lines 2-12), and said each module includes a switch circuit prohibiting data read from a memory cell from being output to the internal data bus in the test mode (Figure 9 # S1, paragraph [0076]).

As per claim 3:

Kawamata teaches the semiconductor integrated circuit according to claim 1, wherein said semiconductor integrated circuit has a plurality of modules having their operations controlled by respective chip select signals (Figure 5 # 110, paragraph [0057], lines 1-6), and said each module has a control circuit controlling an operation of reading or writing data from or into a memory cell (claim 3, lines 13-18), irrespective of a value of said chip select signal, in the test mode.

As per claim 4:

Kawamata teaches the semiconductor integrated circuit according to claim 3, wherein said plurality of modules receive a common address signal sent through a common internal address bus (paragraph [0059], lines 1-3), where said plurality of modules have word lines different in number, said control circuit in a

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module that does not have a maximum number of word lines controls an operation of reading or writing data from or to a memory cell (Figure 5 "WEB", (paragraph [0061], lines 1-3), irrespective of a value of said chip select signal, only when values of one or more prescribed bits forming an address signal are prescribed values, and said prescribed bits are used in specifying a word line of a module having a maximum number of word lines and are not used in specifying a word line of said module that does not have a maximum number of word lines (paragraph [0061], lines 3-10).

As per claim 5:

Kawamata teaches the semiconductor integrated circuit according to claim 1, wherein said semiconductor integrated circuit has a plurality of banks (Figure 7, (paragraph [0067], lines 1-5)) receiving a common address signal and having their operations controlled by one or more bits forming said address signal (Figure 7, "Data BITS", (paragraph [0067], lines 5-7), and said each bank includes a control circuit controlling an operation of reading or writing data from or into a memory cell, irrespective of values of said one or more bits forming an address signal controlling said operation (paragraph [0067], lines 9-11).

As per claim 6:

Kawamata teaches the semiconductor integrated circuit according to claim 1, wherein said semiconductor integrated circuit has a redundancy circuit in a column (paragraph [0052], lines 1-7).

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The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

The factual inquiries set forth in *Graham* v. *John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:

- 1. Determining the scope and contents of the prior art.
- 2. Ascertaining the differences between the prior art and the claims at issue.
- Resolving the level of ordinary skill in the pertinent art.
- Considering objective evidence present in the application indicating obviousness or nonobviousness.

Claims 7-9 are rejected under 35 U.S.C. 103(a) as being unpatentable

Kawamata US PG Pub no. US 2001/0042231 A1, and further in view of Urakawa

US Patent no. US 6,324,106 B2

As per claim 7-9:

Kawamata substantially teaches a semiconductor integrated circuit comprising: a comparator (paragraph [0029], lines 1-2) comparing a value of data read from each memory cell (paragraph [0029], lines 3-4) connected to an activated word line with an expected value to be read from said each memory cell (paragraph [0029], lines 4-5), for each column in a test mode, an error register accumulatively holding error data based on a comparison result by said comparator (paragraph [0030], lines 1-4), wherein each bit (paragraph [0056],

lines 1-2) of said error data indicates said comparison result by said comparator for a corresponding column (paragraph [0039], lines 5-12), and said each bit takes a first logical value when said comparison result for said corresponding column always indicates equality whichever word line is activated, and takes a second logical value when once said comparison result for said corresponding column indicates difference (paragraph [0056], lines 2-6), wherein said semiconductor integrated circuit has a redundancy circuit in a column (paragraph [0052], lines 1-7), and wherein said error register outputs held error data when an address signal indicates a prescribed value (paragraph [0076], lines 1-3)

Kawamata does not explicitly teach a semiconductor integrated circuit wherein said semiconductor integrated circuit further comprising a repair code generation circuit, a program circuit including at least one fuse element for outputting a repair code corresponding to a state of said fuse element, and further elements related to the repair code.

However, Urakawa, in an analogous art, teaches a semiconductor integrated circuit wherein said semiconductor integrated circuit further comprising a repair code generation circuit receiving said error data for generating a repair code for repairing a defective memory cell array using said redundancy circuit (column 6, lines 10-11), a program circuit including at least one fuse element for outputting a repair code corresponding to a state of said fuse element (column 4, lines 39-41); a register holding a repair code (column 6, lines 8-101); a selector selecting and outputting one of the repair code output from said program circuit and the repair code output from said register (column

10, lines 30-35); and a repair control circuit controlling repair of a defective memory cell array in accordance with the repair code output from said selector (column 6, lines 12-14), and a processor (column 6, lines 54-55) controlling an execution of a two-step test, wherein said processor controls writing of test data into a memory cell (column 5, lines 26-28) and reading of test data from a memory cell without causing said repair control circuit to perform repair in a first step of the test (Figure 7 # 3, column 8, lines 42-44), generates a repair code corresponding to error data stored in said error register in said first step of the test for storage into said register, and controls writing of test data (column 5, lines 26-28) into a memory cell and reading of test data from a memory cell (column 5, lines 28-30) while allowing said selector to output the repair code from said register to cause said repair control circuit to perform the repair. Therefore it would have been obvious to one of ordinary skill in the art at the time the invention was made to apply the fuse element and repair code circuitry to memory testing apparatus of Kawamata. This modification would have been obvious to one of ordinary skill in the art because one of ordinary skill in the art would have recognized that applying the fuse would have allowed to shift the comparator result to adjoining memory cell column without using a memory cell column in which the defective cell exists, and repair code circuitry would have allowed for the recovery of the defective bit.

Related Art

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Additional pertinent prior arts, US Pat no. 6684355 B2, US

Pat no. 6590816 B2, US Pat no. 6538929 B2, and US Pat no. 6871297 B2 mention the same semiconductor circuit involving a comparator and repair circuitry are included herein for Applicant's review.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Saqib J. Siddiqui whose telephone number is (571) 272-6553. The examiner can normally be reached on 8:00 to 4:30.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Albert Decady can be reached on (571) 272-3819. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

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